

# Features

- Any frequency between 1 MHz and 220 MHz accurate to 6 decimal places. For frequencies between 220.000001 and 725 MHz, see JYJE9367 datasheet. For standard frequencies up to 325 MHz, see JYJE9365 datasheet.
- LVPECL, LVDS and HCSL output signaling
- 0.1 ps RMS phase jitter (random) for Ethernet applications
- Contact JYJE for ±10 ppm frequency stability
- Wide temperature ranges from -40°C to 105°C
- Industry-standard packages: 7.0 x 5.0 mm, 5.0 x 3.2 mm, 3.2 x 2.5 mm packages

# Applications

- 10/40/100 Gbps Ethernet, SONET, SATA, SAS, Fibre Channel
- Telecom, networking, instrumentation, storage, servers

# **Electrical Characteristics**

All Min and Max limits in the Electrical Characteristics tables are specified over temperature and rated operating voltage with standard output termination show in the termination diagrams. Typical values are at 25°C and nominal supply voltage.

#### Table 1. Electrical Characteristics – Common to LVPECL, LVDS and HCSL (All temperature ranges)

| Parameter               | Symbol  | Min. | Тур. | Max.            | Unit    | Condition  |
|-------------------------|---------|------|------|-----------------|---------|--|
|                         |         |      |      | Frequency Ra    | nge     |  |
| Output Frequency Range  | f       | 1    | -    | 220.000001      | MHz     | Accurate to 6 decimal places   |
|                         |         |      |      | Frequency Stal  | bility  |  |
| Frequency Stability     | F_stab  | -10  | -    | +10             | ppm     | Inclusive of initial tolerance, operating temperature, rated power supply voltage and load variations. Contact JYJE for $\pm 10~\rm ppm$   |
|                         |         | -20  | -    | +20             | ppm     | Inclusive of initial tolerance, operating temperature, rated power   |
|                         |         | -25  | -    | +25             | ppm     | supply voltage and load variations.  |
|                         |         | -50  | -    | +50             | ppm     |  |
| First Year Aging        | F_1y    | -    | ±1   | -               | ppm     | At 25°C  |
|                         |         |      |      | Temperature R   | ange    |  |
| Operating Temperature   | T_use   | -20  | -    | +70             | °C      | Extended Commercial  |
| Range                   |         | -40  | -    | +85             | °C      | Industrial   |
|                         |         | -40  | -    | +95             | °C      |  |
|                         |         | -40  | -    | +105            | °C      | Extended Industrial  |
|                         |         |      |      | Supply Volta    | ge      |  |
| Supply Voltage          | Vdd     | 2.97 | 3.30 | 3.63            | V       |  |
|                         |         | 2.70 | 3.00 | 3.30            | V       |  |
|                         |         | 2.52 | 2.80 | 3.08            | V       |  |
|                         |         | 2.25 | 2.50 | 2.75            | V       |  |
|                         |         |      |      | Input Character | istics  |  |
| Input Voltage High      | VIH     | 70%  | -    | _               | Vdd     | Pin 1, OE  |
| Input Voltage Low       | VIL     | -    | -    | 30%             | Vdd     | Pin 1, OE  |
| Input Pull-up Impedance | Z_in    | -    | 100  | -               | kΩ      | Pin 1, OE logic high or logic low  |
|                         |         |      |      | Output Characte | ristics |  |
| Duty Cycle              | DC      | 45   | -    | 55              | %       |  |
|                         |         |      |      | Startup and OE  | Fiming  |  |
| Startup Time            | T_start | -    | -    | 3.0             | ms      | Measured from the time Vdd reaches its rated minimum value.  |
| OE Enable/Disable Time  | T_oe    | _    | -    | 3.8             | μs      | f = 156.25 MHz. Measured from the time OE pin reaches rated VIH and VIL to the time clock pins reach 90% of swing and high-Z. See Figure 6 and Figure 7.Error! Reference source not found. |



## Table 2. Electrical Characteristics – LVPECL

| Parameter                            | Symbol   | Min.    | Тур.           | Max.          | Unit     | Condition   |
|--------------------------------------|----------|---------|----------------|---------------|----------|---|
|                                      |          |         | Curr           | ent Consum    | ption    |   |
| Current Consumption                  | ldd      | -       | -              | 89            | mA       | Excluding Load Termination Current, Vdd = 3.3V or 2.5V  |
| OE Disable Supply Current            | I_OE     | -       | -              | 58            | mA       | OE = Low  |
| Output Disable Leakage<br>Current    | I_leak   | -       | 0.15           | -             | μA       | OE = Low  |
| Maximum Output Current               | I_driver | -       | -              | 32            | mA       | Maximum average current drawn from OUT+ or OUT-   |
|                                      |          |         | Outp           | ut Character  | ristics  |   |
| Output High Voltage                  | VOH      | Vdd-1.1 | -              | Vdd-0.7       | V        | See Figure 2  |
| Output Low Voltage                   | VOL      | Vdd-1.9 | -              | Vdd-1.5       | V        | See Figure 2  |
| Output Differential Voltage<br>Swing | V_Swing  | 1.2     | 1.6            | 2.0           | V        | See Figure 3  |
| Rise/Fall Time                       | Tr, Tf   | -       | 225            | 290           | ps       | 20% to 80%, See Figure 3  |
|                                      |          |         | Jitter –       | 7.0 x 5.0 mm  | Package  |   |
| RMS Period Jitter <sup>[1]</sup>     | T_jitt   | -       | 1.0            | 1.6           | ps       | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3V or 2.5V  |
| RMS Phase Jitter (random)            | T_phj    | _       | 0.225          | 0.270         | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -20 to 70°C and -40 to $85^{\circ}$ C            |
|                                      |          | _       | 0.225          | 0.300         | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -40 to $95^{\circ}$ C and -40 to $105^{\circ}$ C |
|                                      |          | _       | 0.1            | -             | ps       | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels.             |
|                                      |          | Jit     | ter – 5.0 x 3. | 2 and 3.2 x 2 | .5 mm Pa | ackages   |
| RMS Period Jitter <sup>[1]</sup>     | T_jitt   | -       | 1.0            | 1.6           | ps       | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3V or 2.5V  |
| RMS Phase Jitter (random)            |          | -       | 0.225          | 0.275         | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -20 to 70°C and -40 to 85°C                      |
|                                      |          | _       | 0.225          | 0.340         | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -40 to 95°C and -40 to 105°C                     |
|                                      |          | _       | 0.1            | _             | ps       | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels.             |
|                                      | -        |         |                |               |          |   |

Notes: 1. Measured according to JESD65B.



### Table 3. Electrical Characteristics – LVDS

| Parameter                         | Symbol | Min.  | Тур.            | Max.         | Unit     | Condition   |
|-----------------------------------|--------|-------|-----------------|--------------|----------|---|
|                                   |        |       | Cui             | rent Consu   | nption   |   |
| Current Consumption               | ldd    | -     | -               | 79           | mA       | Excluding Load Termination Current, Vdd = 3.3V or 2.5V  |
| OE Disable Supply Current         | I_OE   | -     | -               | 58           | mA       | OE = Low  |
| Output Disable Leakage<br>Current | I_leak | -     | 0.15            | -            | μΑ       | OE = Low  |
|                                   |        |       | Out             | put Characte | eristics |   |
| Differential Output Voltage       | VOD    | 250   | -               | 450          | mV       | See Figure 4  |
| VOD Magnitude Change              | ΔVOD   | -     | -               | 50           | mV       | See Figure 4  |
| Offset Voltage                    | VOS    | 1.125 | -               | 1.375        | V        | See Figure 4  |
| VOS Magnitude Change              | ΔVOS   | -     | -               | 50           | mV       | See Figure 4  |
| Rise/Fall Time                    | Tr, Tf | -     | 400             | 470          | ps       | Measured with 2 pF capacitive loading to GND, 20% to 80%, see Figure 5  |
|                                   | ·      |       | Jitter -        | 7.0 x 5.0 mr | n Packag | e   |
| RMS Period Jitter <sup>[2]</sup>  | T_jitt | -     | 1.0             | 1.6          | ps       | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3V or 2.5V  |
| RMS Phase Jitter (random)         | T_phj  | -     | 0.215           | 0.265        | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all<br>Vdd levels, includes spurs. Temperature ranges -20 to 70°C<br>and -40 to 85°C              |
|                                   |        | -     | 0.215           | 0.300        | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -40 to $95^{\circ}C$ and -40 to $105^{\circ}C$ |
|                                   |        | -     | 0.1             | _            | ps       | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels.           |
|                                   |        | Ji    | itter – 5.0 x 3 | .2 and 3.2 x | 2.5 mm P | ackages   |
| RMS Period Jitter <sup>[2]</sup>  | T_jitt | _     | 1.0             | 1.6          | ps       | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3V or 2.5V  |
| RMS Phase Jitter (random)         | T_phj  | -     | 0.235           | 0.275        | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -20 to 70°C and -40 to 85°C                    |
|                                   |        | -     | 0.235           | 0.320        | ps       | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -40 to $95^{\circ}C$ and -40 to $105^{\circ}C$ |
|                                   |        | -     | 0.1             | -            | ps       | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels.           |

Notes: 2. Measured according to JESD65B.



### Table 4. Electrical Characteristics – HCSL

| Parameter                            | Symbol   | Min.  | Тур.           | Max.          | Unit      | Condition   |
|--------------------------------------|----------|-------|----------------|---------------|-----------|---|
|                                      |          |       | Curi           | rent Consum   | ption     |   |
| Current Consumption                  | ldd      | -     | -              | 89            | mA        | Excluding Load Termination Current, Vdd = 3.3V or 2.5V  |
| OE Disable Supply Current            | I_OE     | -     | -              | 58            | mA        | OE = Low  |
| Output Disable Leakage<br>Current    | I_leak   | Ι     | 0.15           | -             | μA        | OE = Low  |
| Maximum Output Current               | I_driver | -     | -              | 35            | mA        | Maximum average current drawn from OUT+ or OUT-   |
|                                      |          |       | Outp           | out Characte  | ristics   |   |
| Output High Voltage                  | VOH      | 0.60  | -              | 0.90          | V         | See Figure 2  |
| Output Low Voltage                   | VOL      | -0.05 | -              | 0.08          | V         | See Figure 2  |
| Output Differential Voltage<br>Swing | V_Swing  | 1.2   | 1.4            | 1.80          | V         | See Figure 3  |
| Rise/Fall Time                       | Tr, Tf   | Ι     | 360            | 465           | ps        | Measured with 2 pF capacitive loading to GND, 20% to 80%, see Figure 3 $$   |
|                                      |          |       | Jitter –       | 7.0 x 5.0 mm  | Package   | )   |
| RMS Period Jitter <sup>[3]</sup>     | T_jitt   | -     | 1.0            | 1.6           | ps        | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3V or 2.5V  |
| RMS Phase Jitter (random)            | T_phj    | _     | 0.220          | 0.270         | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -20 to 70°C and -40 to $85^{\circ}$ C          |
|                                      |          | _     | 0.220          | 0.300         | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -40 to $95^{\circ}C$ and -40 to $105^{\circ}C$ |
|                                      |          | -     | 0.1            | -             | ps        | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels.           |
|                                      |          | Jit   | ter – 5.0 x 3. | 2 and 3.2 x 2 | 2.5 mm Pa | ackages   |
| RMS Period Jitter <sup>[3]</sup>     | T_jitt   | -     | 1.0            | 1.6           | ps        | f = 100, 156.25 or 212.5 MHz, Vdd = 3.3V or 2.5V  |
| RMS Phase Jitter (random)            | T_phj    | -     | 0.230          | 0.275         | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -20 to 70°C and -40 to $85^{\circ}$ C          |
|                                      |          | -     | 0.230          | 0.340         | ps        | f = 156.25 MHz, Integration bandwidth = 12 kHz to 20 MHz, all Vdd levels, includes spurs. Temperature ranges -40 to 95°C and -40 to 105°C                   |
|                                      |          | -     | 0.1            | -             | ps        | f = 156.25 or 322.265625 MHz, IEEE802.3-2005 10GbE jitter<br>mask integration bandwidth = 1.875 MHz to 20 MHz, includes<br>spurs, all Vdd levels.           |

Notes:

3. Measured according to JESD65B.

## Table 5. Pin Description

| Pin | Мар   | Functionality       |   |  |  |  |
|-----|-------|---------------------|---|--|--|--|
| 1   | OE/NC | Output Enable       | H <sup>[4]</sup> : specified frequency output                               |  |  |  |
|     |       | (OE)                | L: output is high impedance   |  |  |  |
|     |       | Non Connect<br>(NC) | H or L or Open: No effect on output frequency or other device functions     |  |  |  |
| 2   | NC    | NA                  | No Connect; Leave it floating or connect to GND for better heat dissipation |  |  |  |
| 3   | GND   | Power               | Vdd Power Supply Ground   |  |  |  |
| 4   | OUT+  | Output              | Oscillator output   |  |  |  |
| 5   | OUT-  | Output              | Complementary oscillator output   |  |  |  |
| 6   | Vdd   | Power               | Power supply voltage <sup>[5]</sup>   |  |  |  |





#### Notes:

4. In OE mode, a pull-up resistor of 10 k $\Omega$  or less is recommended if pin 1 is not externally driven.

5. A capacitor of value 0.1 μF or higher between Vdd and GND is required. An additional 10 μF capacitor between Vdd and GND is required for the best phase jitter performance.



### Table 6. Absolute Maximum Ratings

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

| Parameter  | Min. | Max.       | Unit |
|--|------|------------|------|
| Vdd  | -0.5 | 4.0        | V    |
| VIH  |      | Vdd + 0.3V | V    |
| VIL  | -0.3 |            | V    |
| Storage Temperature  | -65  | 150        | °C   |
| Maximum Junction Temperature   |      | 130        | ٥C   |
| Soldering Temperature (follow standard Pb-free soldering guidelines) |      | 260        | °C   |

### Table 7. Thermal Considerations<sup>[6]</sup>

| Package     | $	heta_{	extsf{JA}}$ , 4 Layer Board (°C/W) | $	heta_{	extsf{Jc}}$ , Bottom (°C/W) |
|-------------|---|--------------------------------------|
| 3225, 6-pin | 80  | 30                                   |
| 5032, 6-pin | TBD   | TBD                                  |
| 7050, 6-pin | 52  | 19                                   |

Notes:

6. Refer to JESD51 for  $\theta_{JA}$  and  $\theta_{JC}$  definitions, and reference layout used to determine the  $\theta_{JA}$  and  $\theta_{JC}$  values in the above table.

### Table 8. Maximum Operating Junction Temperature<sup>[7]</sup>

| Max Operating Temperature (ambient) | Maximum Operating Junction Temperature |
|-------------------------------------|--|
| 70°C                                | 95°C                                   |
| 85°C                                | 110°C                                  |
| 95°C                                | 120°C                                  |
| 105°C                               | 130°C                                  |

Notes:

7. Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

### Table 9. Environmental Compliance

| Parameter  | Test Conditions           | Value    | Unit |
|--|---------------------------|----------|------|
| Mechanical Shock Resistance  | MIL-STD-883F, Method 2002 | 10,000   | G    |
| Mechanical Vibration Resistance                                      | MIL-STD-883F, Method 2007 | 70       | G    |
| Soldering Temperature (follow standard Pb free soldering guidelines) | MIL-STD-883F, Method 2003 | 260      | °C   |
| Moisture SenJYJEivity Level  | MSL1 @ 260°C              |          |      |
| Electrostatic Discharge (HBM)  | HBM, JESD22-A114          | 2,000    | V    |
| Charge-Device Model ESD Protection                                   | JESD220C101               | 750      | V    |
| Latch-up Tolerance   | JESD78 C                  | ompliant |      |



# Waveform Diagrams



Figure 2. LVPECL/HCSL Voltage Levels per Differential Pin (OUT+/OUT-)



Figure 3. LVPECL/HCSL Voltage Levels Across Differential Pair



# Waveform Diagrams (continued)



Figure 4. LVDS Voltage Levels per Differential Pin (OUT+/OUT-)



Figure 5. LVDS Differential Waveform



Figure 6. Hardware OE Enable Timing



Figure 7. Hardware OE Disable Timing



# **Termination Diagrams**

# LVPECL:



Figure 8. LVPECL with AC-coupled Termination



Figure 9. LVPECL DC-coupled Load Termination with Thevenin Equivalent Network



Figure 10. LVPECL with Y-Bias Termination



# Termination Diagrams (Continued)



Figure 11. LVPECL with DC-coupled Parallel Shunt Load Termination



# **Termination Diagrams (continued)**

## LVDS:



Figure 12. LVDS single DC Termination at the Load



Figure 13. LVDS Double AC Termination with Capacitor Close to the Load



Figure 14. LVDS Double DC Termination



# **Termination Diagrams (Continued)**

HCSL:



Figure 15. HCSL Interface Termination



# **Ordering Information**

# JYJE9366AC- 1B2-33E125.000000T



#### Notes:

8. Contact JYJE for ±10 ppm option

9. Bulk is available for sampling only

### Table 10. Ordering Codes for Supported Tape & Reel Packing Method

| Device Size<br>(mm x mm) | 8 mm T&R<br>(3ku) | 8 mm T&R<br>(1ku) | 12 mm T&R<br>(3ku) | 12 mm T&R<br>(1ku) | 16 mm T&R<br>(3ku) | 16 mm T&R<br>(1ku) |
|--------------------------|-------------------|-------------------|--------------------|--------------------|--------------------|--------------------|
| 7.0 x 5.0                | —                 | —                 | —                  | —                  | Т                  | Y                  |
| 5.0 x 3.2                |                   |                   | Т                  | Y                  |                    |                    |
| 3.2 x 2.5                | D                 | E                 |                    |                    | _                  | —                  |



### Table 11. Additional Information

| Document               | Description  |
|------------------------|--|
| ECCN #: EAR99          | Five character designation used on the commerce Control List (CCL) to identify dual use items for export control purposes. |
| Part number Generator  | Tool used to create the part number based on desired features.   |
| Manufacturing Notes    | Tape & Reel dimension, reflow profile and other manufacturing related info   |
| Qualification Reports  | RoHS report, reliability reports, compoJYJEion reports   |
| Performance Reports    | Additional performance data such as phase noise, current consumption and jitter for selected frequencies                   |
| Termination Techniques | Termination design recommendations   |
| Layout Techniques      | Layout recommendations   |

# Table 12. Revision History

| Revision | Release Date | Change Summary   |
|----------|--------------|--|
| 1.0      | 09/06/2017   | Final release  |
| 1.04     | 04/17/2018   | Added 5032 package<br>Added -40 to 95C and -40 to 105C temperature ranges<br>Corrected minor errors<br>Added Additional Information Table. |
| 1.05     | 10/01/2018   | Updated Ordering Information and performed minor edits<br>Fixed formatting<br>Updated 3225 package drawing to POD 38 RevA                  |